

$V_{RM} = 200\text{ V}$ ,  $I_{F(AV)} = 0.8\text{ A}$ ,  $t_{rr} = 400\text{ ns}$

Fast Recovery Diode

## AU02Z

### Description

The AU02Z is a fast recovery diode of 200 V / 0.8 A. The maximum  $t_{rr}$  of 400 ns is realized by optimizing a life-time control.

### Features

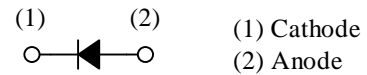
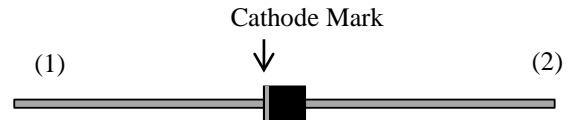
- $V_{RM}$ ----- 200 V
- $I_{F(AV)}$ ----- 0.8 A
- $V_F$ ----- 1.3 V
- $t_{rr1}$ ----- 400 ns
- Bare Leads: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

### Applications

- Secondary-side Rectifier Diode  
(Flyback Converter, LLC Converter, etc.)
- Freewheel Diode  
(Offline Buck Converter, Offline Buck-boost Converter, etc.)

### Package

Axial ( $\phi 2.4 \times 2.9L / \phi 0.57$ )



(1) Cathode  
(2) Anode

Not to scale

**Absolute Maximum Ratings**

Unless otherwise specified,  $T_A = 25\text{ }^\circ\text{C}$ .

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage	$V_{RSM}$		250	V
Repetitive Peak Reverse Voltage	$V_{RM}$		200	V
Average Forward Current	$I_{F(AV)}$	See Figure 2 and Figure 3	0.8	A
Surge Forward Current	$I_{FSM}$	Half cycle sine wave, positive side, 10 ms, 1 shot	25	A
$I^2t$ Limiting Value	$I^2t$	$1\text{ ms} \leq t \leq 10\text{ ms}$	3.13	$\text{A}^2\text{s}$
Junction Temperature	$T_J$		-40 to 150	$^\circ\text{C}$
Storage Temperature	$T_{STG}$		-40 to 150	$^\circ\text{C}$

**Electrical Characteristics**

Unless otherwise specified,  $T_A = 25\text{ }^\circ\text{C}$ .

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage Drop	$V_F$	$T_J = 25\text{ }^\circ\text{C}$ , $I_F = 0.8\text{ A}$	—	—	1.3	V
		$T_J = 100\text{ }^\circ\text{C}$ , $I_F = 0.8\text{ A}$	—	0.8	—	V
Reverse Leakage Current	$I_R$	$V_R = V_{RM}$	—	—	10	$\mu\text{A}$
Reverse Leakage Current under High Temperature	$H \cdot I_R$	$V_R = V_{RM}$ , $T_J = 100\text{ }^\circ\text{C}$	—	—	250	$\mu\text{A}$
Reverse Recovery Time	$t_{rr1}$	$I_F = I_{RP} = 10\text{ mA}$ , 90% recovery point, $T_J = 25\text{ }^\circ\text{C}$	—	—	400	ns
	$t_{rr2}$	$I_F = 10\text{ mA}$ , $I_{RP} = 20\text{ mA}$ , 75% recovery point, $T_J = 25\text{ }^\circ\text{C}$	—	—	180	ns
Thermal Resistance <sup>(1)</sup>	$R_{th(J-L)}$	See Figure 1	—	—	22	$^\circ\text{C/W}$

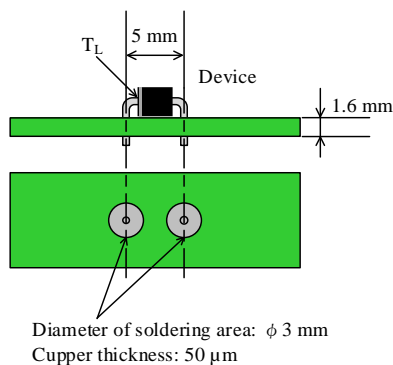


Figure 1. Lead Temperature Measurement Conditions

<sup>(1)</sup>  $R_{th(J-L)}$  is thermal resistance between junction and lead.

Rating and Characteristic Curves

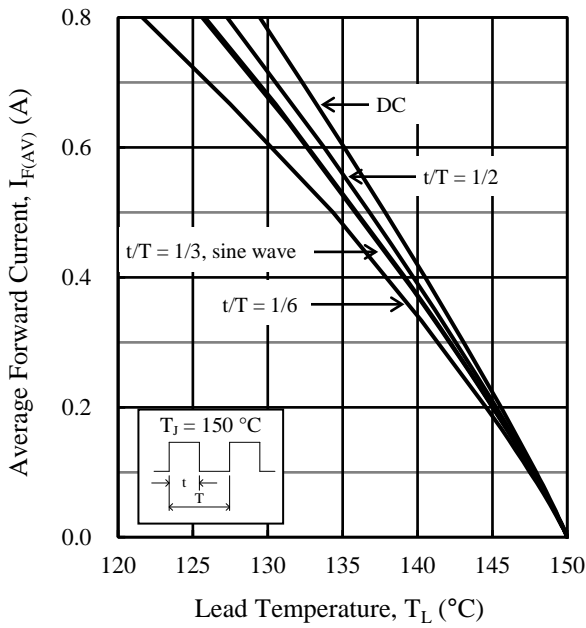


Figure 2. Typical Characteristics:  $I_{F(AV)}$  vs.  $T_L^{(2)}$  ( $V_R = 0\text{ V}$ )

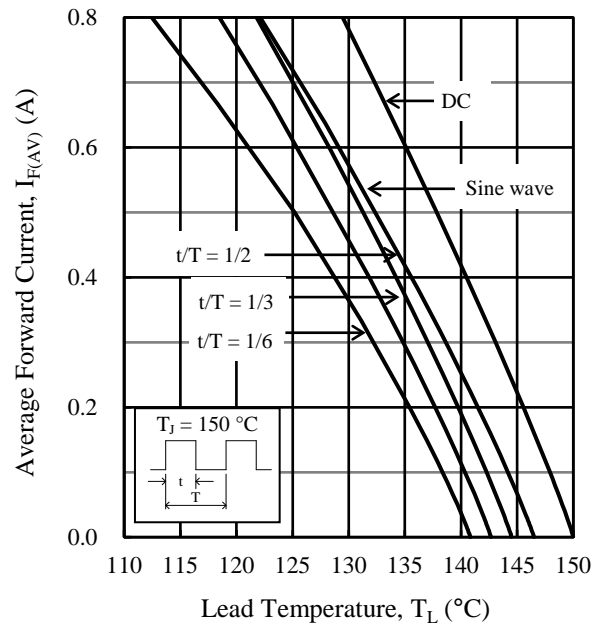


Figure 3. Typical Characteristics:  $I_{F(AV)}$  vs.  $T_L^{(2)}$  ( $V_R = 200\text{ V}$ )

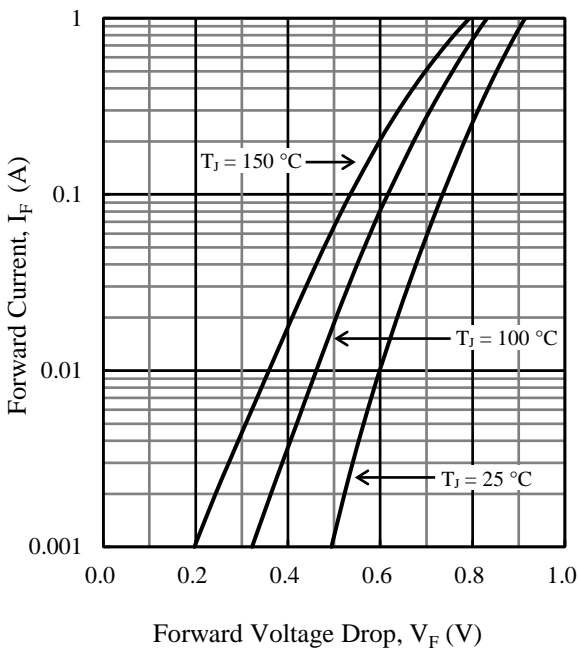


Figure 4. Typical Characteristics:  $I_F$  vs.  $V_F$

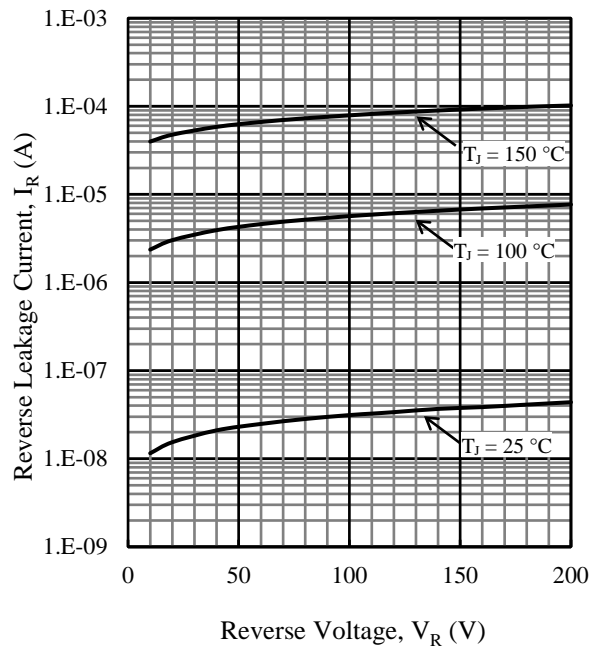


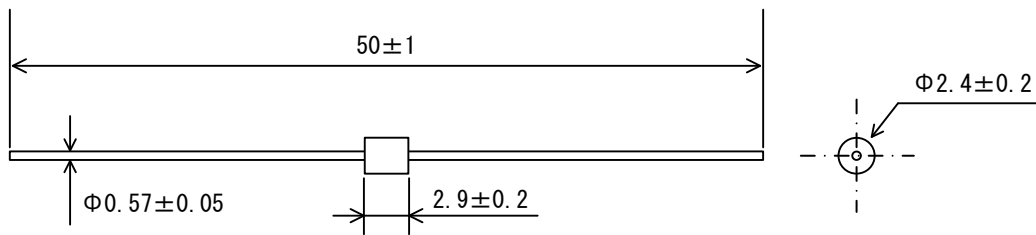
Figure 5. Typical Characteristics:  $I_R$  vs.  $V_R$

<sup>(2)</sup> See Figure 1 for the lead temperature measurement conditions.

# AU02Z

## Physical Dimensions

- Axial ( $\phi 2.4 \times 2.9L / \phi 0.57$ )



### NOTES:

- Dimensions in millimeters
- Bare leads: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits:
  - Flow:  $260 \pm 5 \text{ }^\circ\text{C} / 10 \pm 1 \text{ s}$ , 2 times
  - Soldering Iron:  $380 \pm 10 \text{ }^\circ\text{C} / 3.5 \pm 0.5 \text{ s}$ , 1 time (Soldering should be at a distance of at least 1.5 mm from the body of the product.)

## Marking Diagram

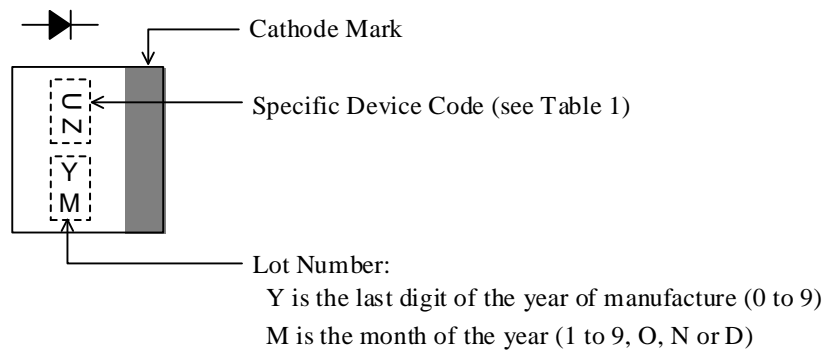


Table 1. Specific Device Code

Specific Device Code	Part Number
UZ	AU02Z

### NOTE:

- Marked in yellow-based color

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